DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE CAPABLE OF ETCHING A MULTI-LAYER OF ORGANIC FILMS AT A HIGH SELECTIVITY the specification of which (check one)

(x) is attached hereto: () was filed on as	United States Application	Number or PCT Internationa	l Application Number	
on, and was amended on	(if appl	icable).		
I hereby state that I have reviewed and understan amendment referred to above. I acknowledge the Federal Regulation, §1.56 I hereby claim foreign for patent or inventor's certificate listed below an disclosing the subject matter claimed in their app or (2) if no priority is claimed, before the filing d	e duty to disclose informat in priority benefits under T id have also identified belo dication and having a filin	tion which is material to paten Title 35, United States Code, § ow any foreign application for	tability as defined in T 119/365 of any foreign patent or inventor's ce	itle 37, Code of application(s) rificate
·	Prior foreign A	prication(s)		
Number	Country	Day/Month/Year Filed	Priority Claimed	
047358/2001	Japan	22/2/2001	(X) Yes () N	0
			() Yes () N	0
			() Yes () N	o
States application in the manner provided by the information which is material to patentability as filing date of the prior application and the nation (Application Number) Day/Month/	defined in Title 37, Code of all or PCT international file	of Federal Regulations, §1 56	which became availab	le between the
I hereby appoint Donald W. Muirhead, Reg. No. prosecute this application and to transact all busing the state of the state	. 33,978; Anne E. Saturnel iness in the Patent and Tra	enark Office connected ther	ewith.	9 as attomeys to
de much seen, aven de seen seen seen seen seen seen seen	Patent Group Hutchins, Who 101 Federal St Boston, MA			
I hereby declare that all statements made herein believed to be true; and further that these statem punishable by fine or imprisonment, or both, unjeopardize the validity of the application or any	ients were made with the k der Section 1001 of Title 1	nowledge that willful false sta	itements and the like si	o made are
Inventor's signature Hiroto Chi	take (杏	<u> </u>	Date February	21,2002
Full name of sole or first inventor (given name,	family name) Hirot	o OHTAKE		
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Inventor's signature Shinolic	e Sactoh		DateFebruary	21,2002
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(X) Additional inventors are being named on separately numbered sheets attached hereto

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION (continued)

Inventor's signature Munchino Jada (E)	Date February 21,2002			
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Inventor's signature Jamis Jans V January Full name of fourth inventor (given name, family name) Yoshihiro HAYASHI	Date February 21,2002			
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Inventor's signature				
Residence Post Office Address (include zip code)	Citizenship			
Invertor's signature				
Residence				
Inventor's signature Full name of seventh inventor (given name, family name)				
Residence				
Post Office Address (include zip code)				
Inventor's signature Full name of eighth inventor (given name, family name)				
Residence				
Post Office Address (include zip code)				